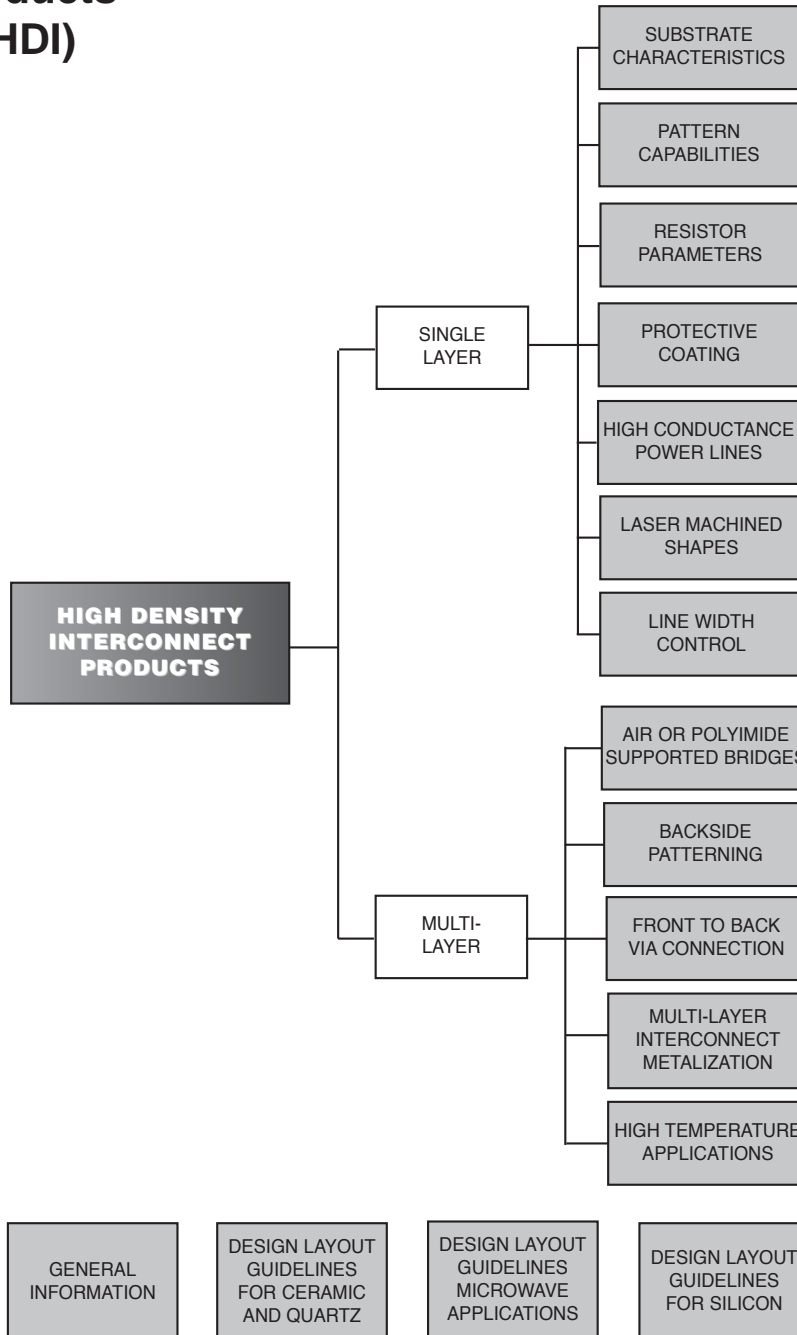
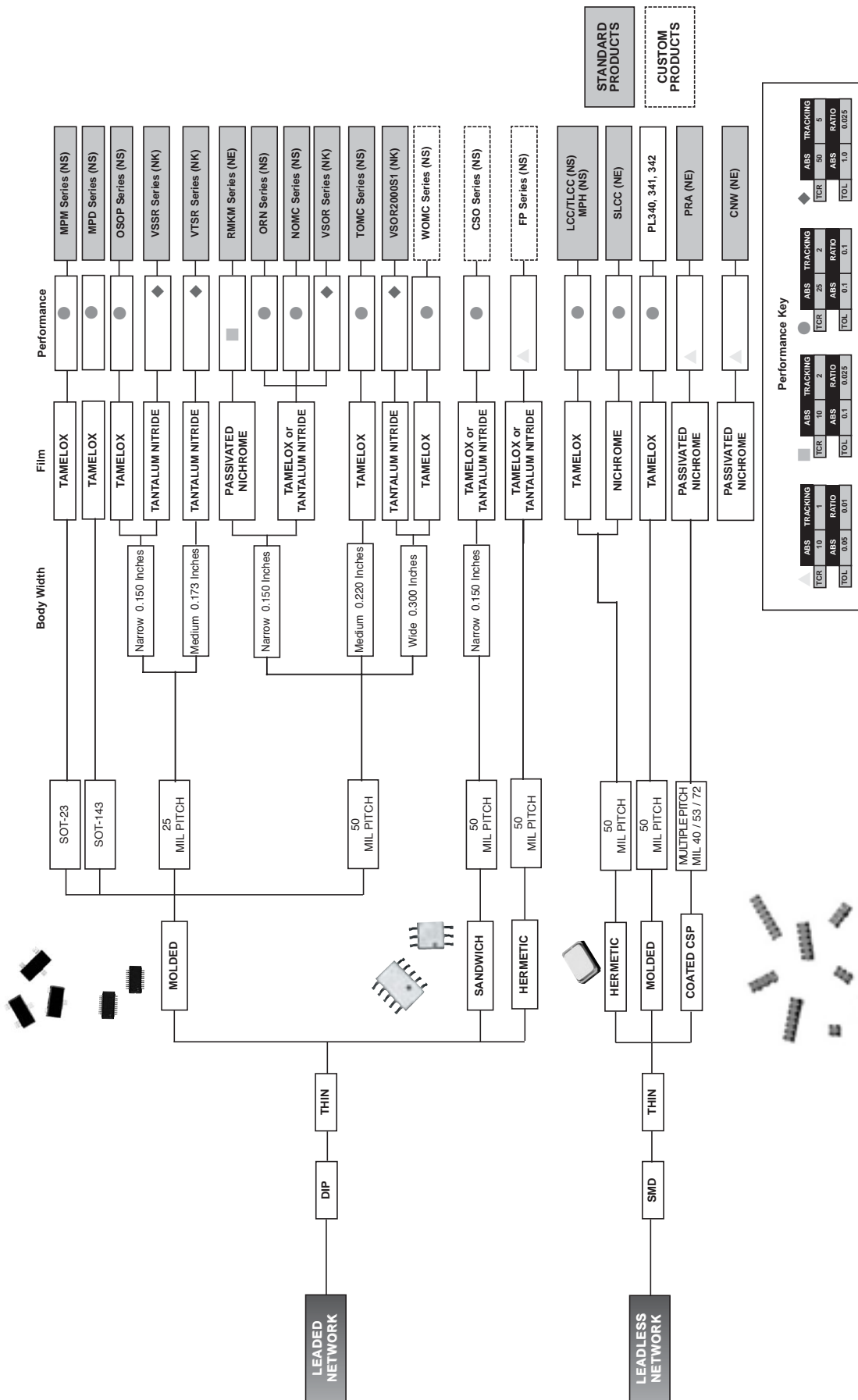




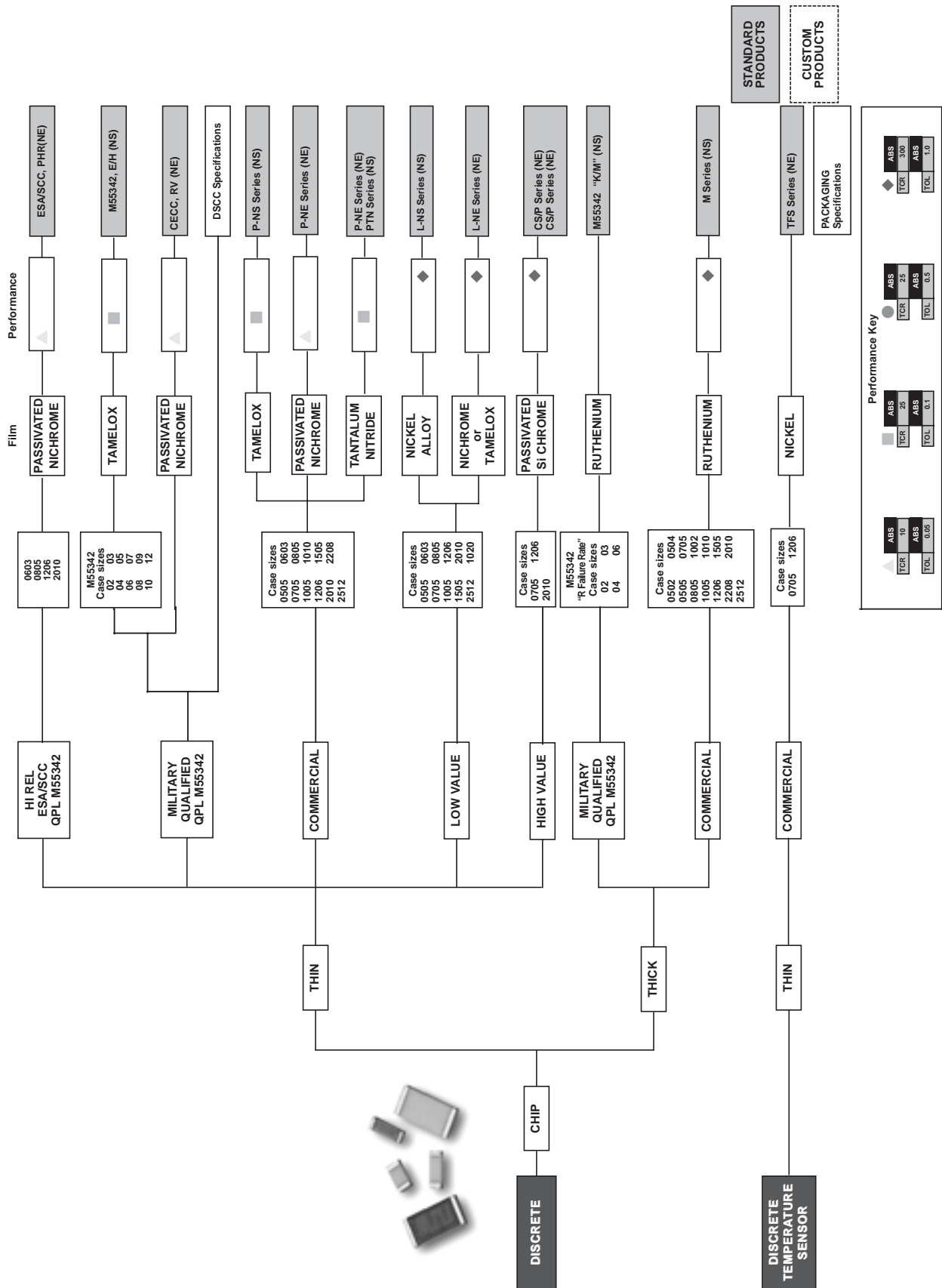
Thin Film High Density Interconnect Products (HDI)



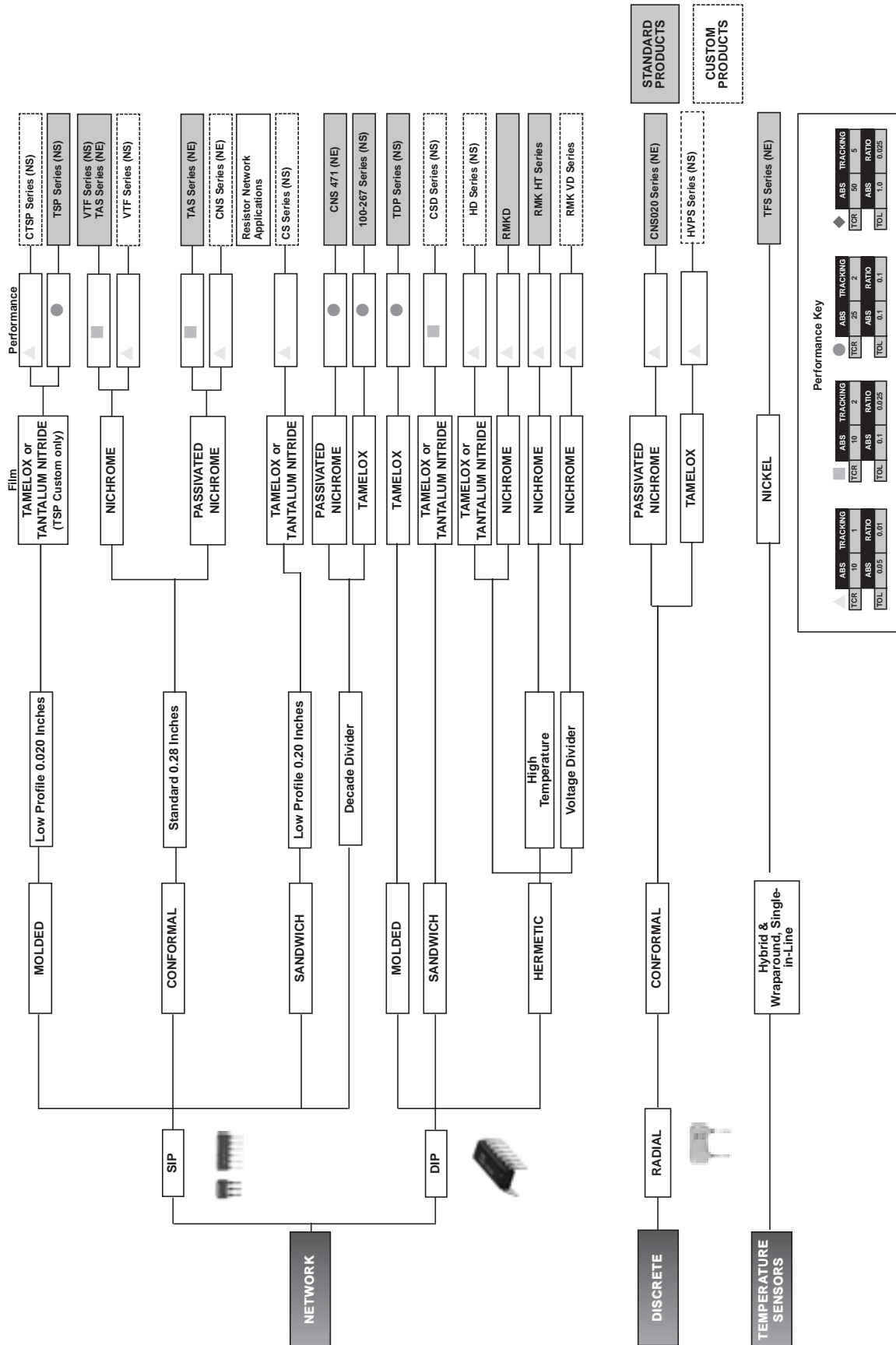
Thin Film Surface Mount Resistor Networks



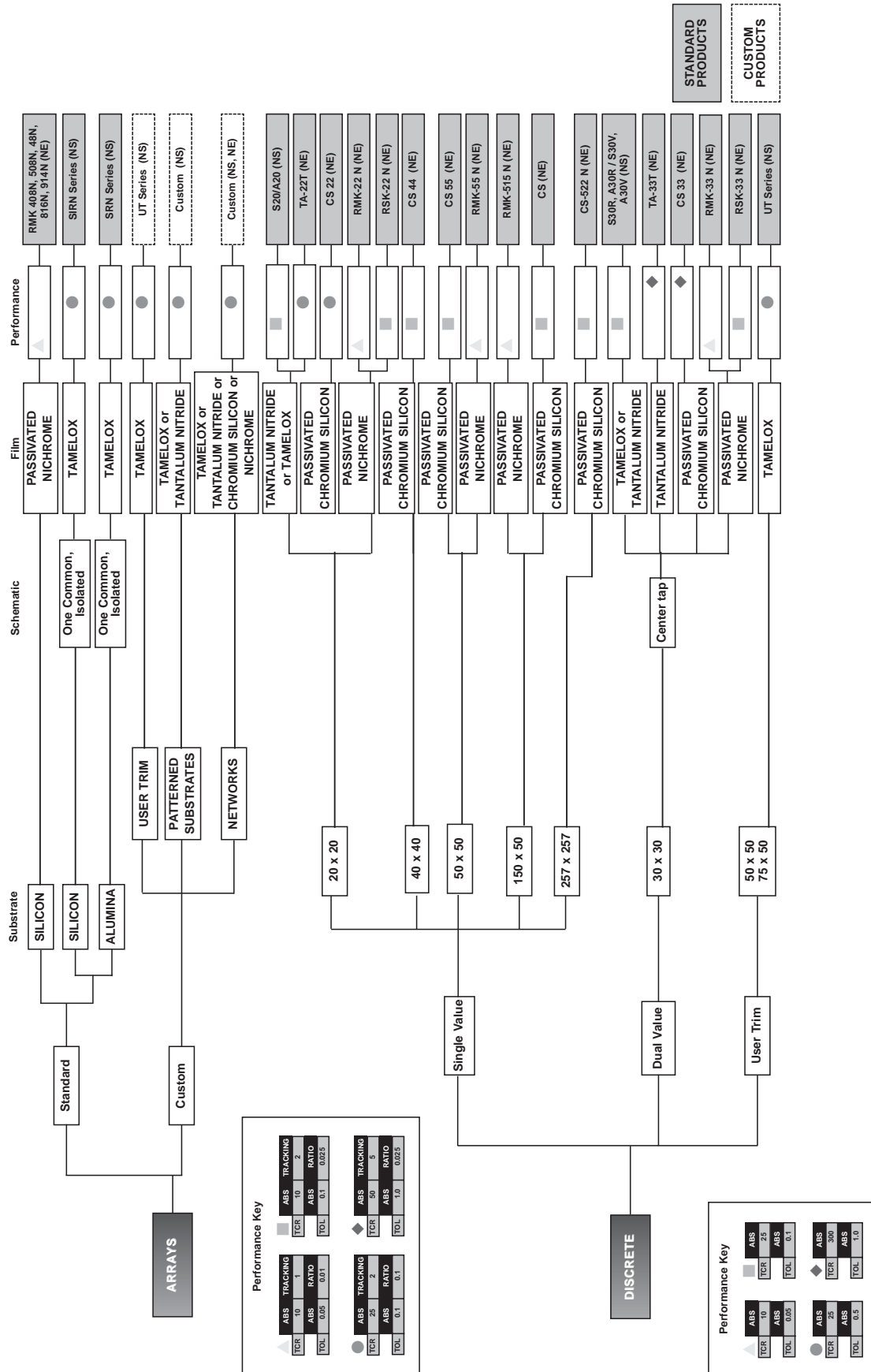
Thin Film Surface Mount Resistor Chips



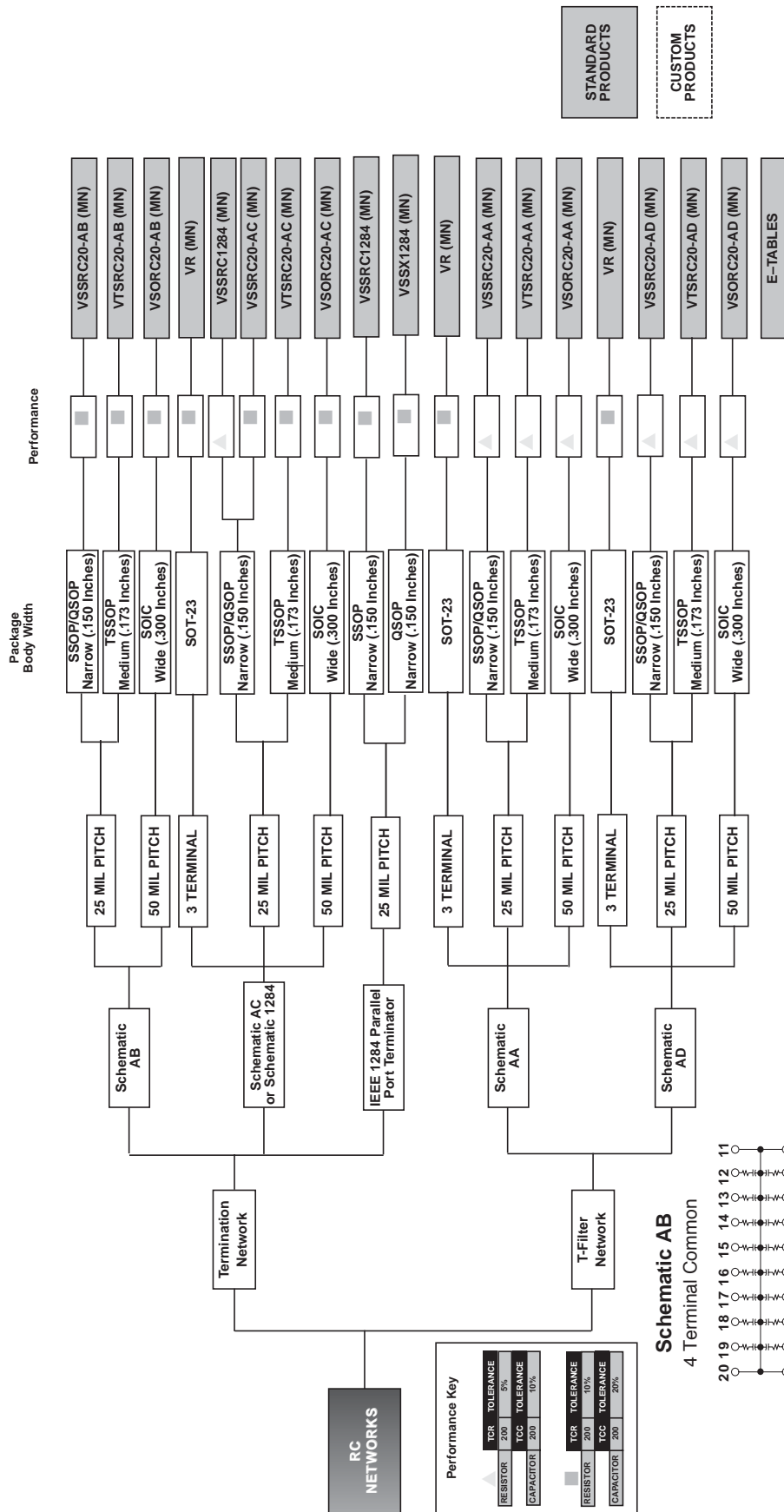
Thin Film Through Hole Resistors



Thin Film Hybrid Resistors, Wire Bondable

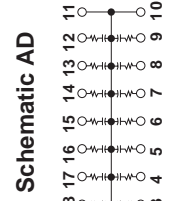
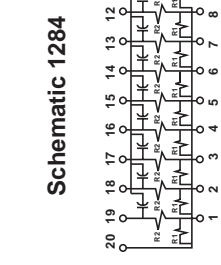
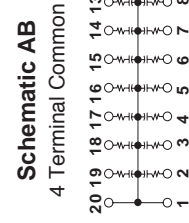


Thin Film RC Surface Mount Networks

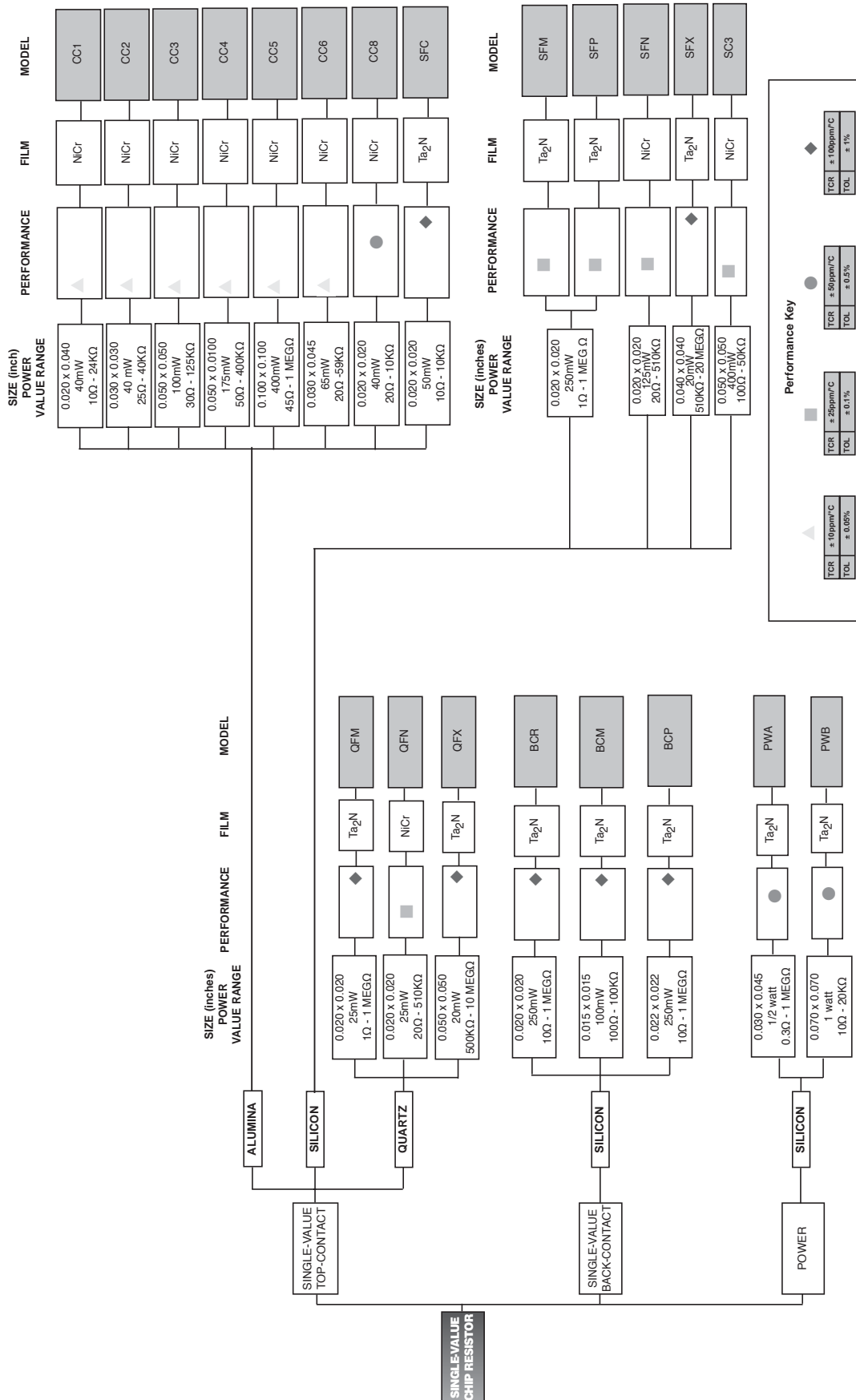


Performance Key

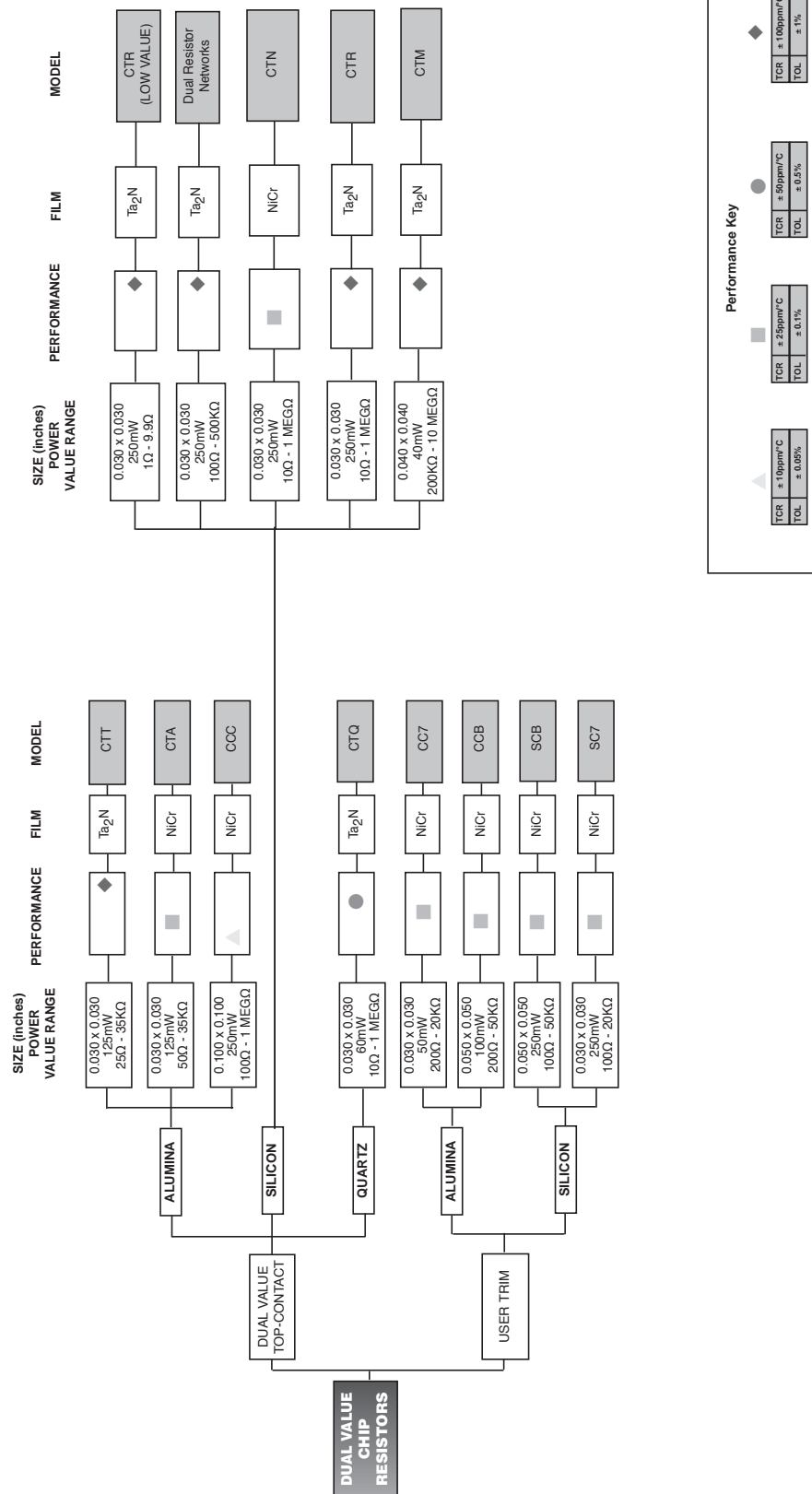
▲	TCR TOLERANCE	200	5%
■	TCC TOLERANCE	200	10%
■	TCR TOLERANCE	200	10%
■	TCC TOLERANCE	200	20%



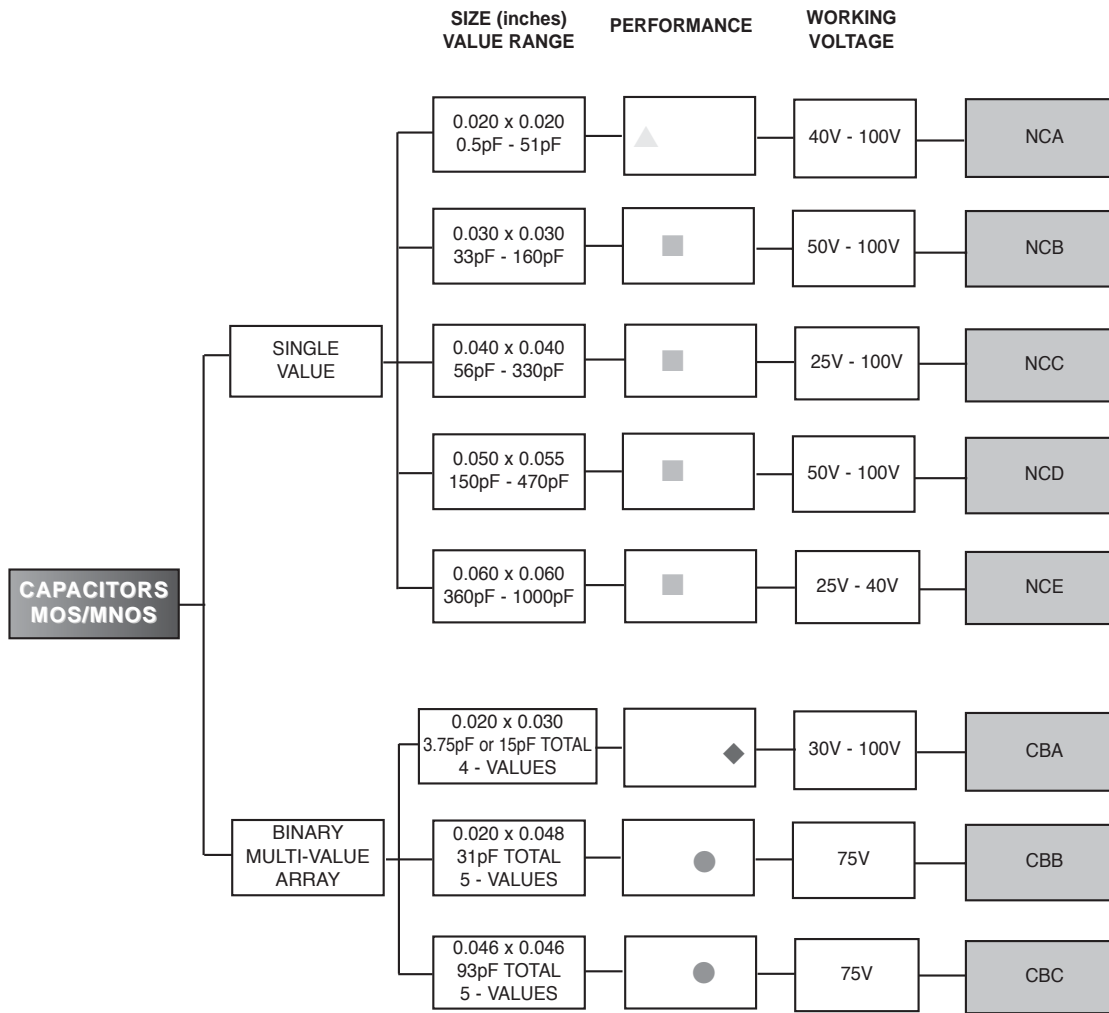
Thin Film Chip Resistors Wire Bondable Single Value



Thin Film Chip Resistors Wire Bondable Dual Value

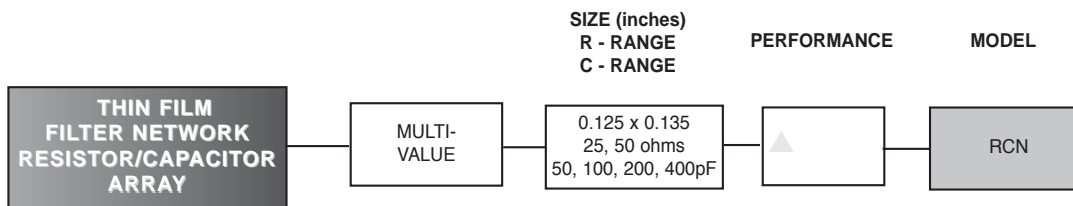


Thin Film Capacitors MOS/MNOS (Wire Bondable Back Contact)



Performance Key			
TCC + 15 ± 25ppm/°C	TCC + 45 ± 25ppm/°C	TCC + 45 ± 25ppm/°C	TCC + 45 ± 25ppm/°C
TOL 5%	TOL 5%	TOL 10%	TOL 25%

**Thin Film
Filter Network
Resistor-Capacitor
Array
(Wire Bondable)**

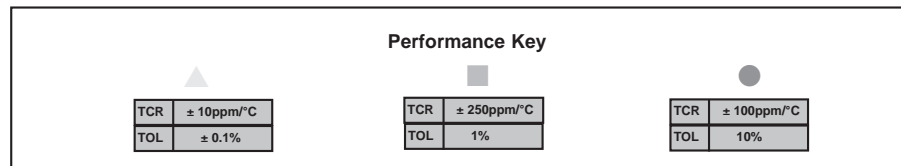
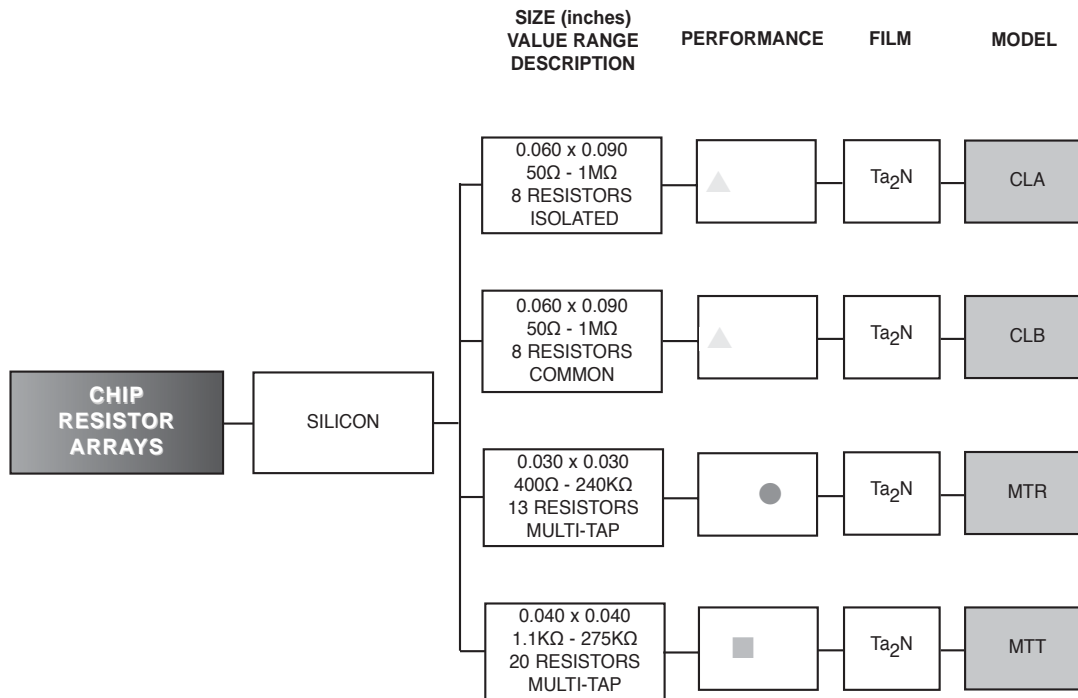


Performance Key

▲

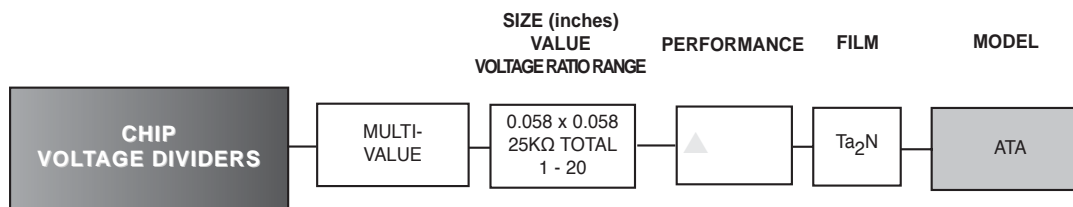
TCR	± 100ppm/°C
TOL	± 10%
TCC	± 200ppm/°C
TOL	± 10%

Thin Film Chip Resistor Arrays Wire Bondable





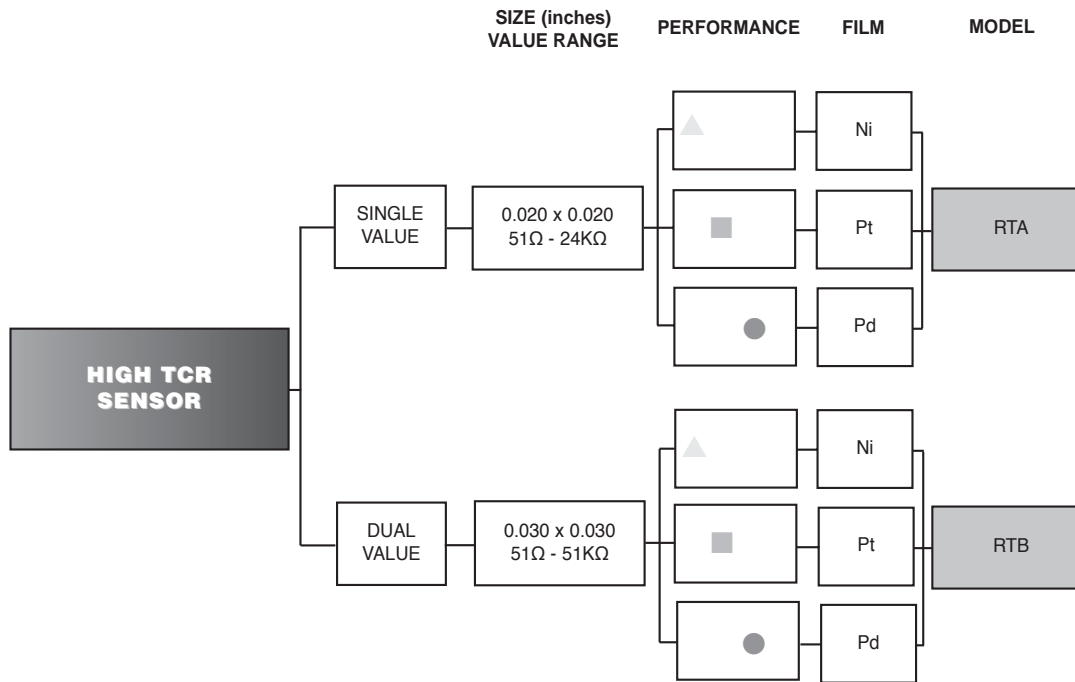
Thin Film Chip Voltage Dividers



Performance Key

TCR	± 50ppm/°C
TOL	± 5%

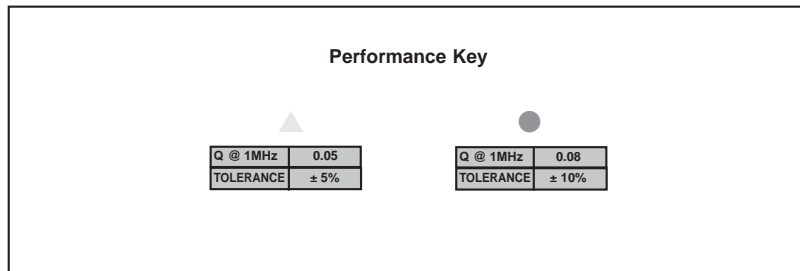
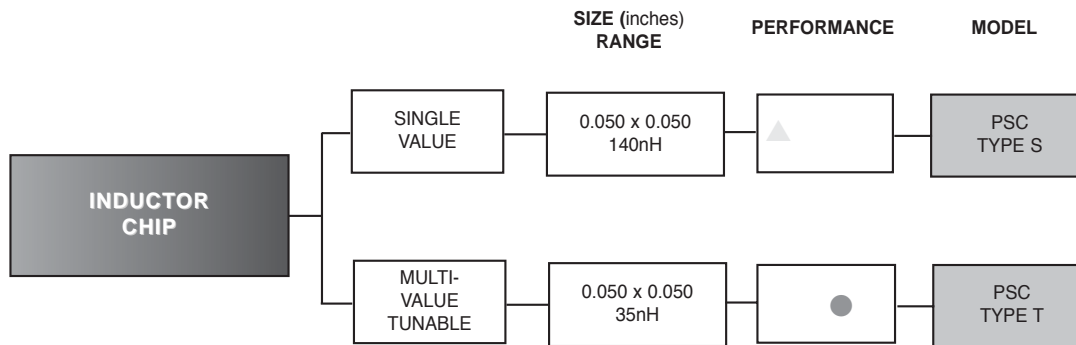
Thin Film High TCR Sensor (Wire Bondable Top Contact)



Performance Key

TCR + 1800ppm/°C TOL 1%	TCR + 3000ppm/°C TOL 1%	TCR + 4800ppm/°C TOL 1%

Thin Film Inductor (Wire Bondable)





**Thin Film
Metalized
Plates**

